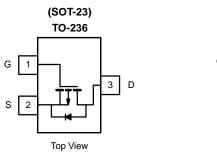
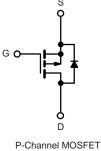


P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) Typ.	I _D (A) ^a	Q _g (Typ.)		
	0.046 at V _{GS} = - 10 V	- 5.6			
- 30	0.049 at V _{GS} = - 6 V	- 5	11.4 nC		
	0.054 at V _{GS} = - 4.5 V	-4.5			





FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g Tested



APPLICATIONS

- For Mobile Computing
 - Load Switch - Notebook Adaptor Switch
 - DC/DC Converter

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 30	V		
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		- 5.6		
Continuous Drain Current (T. 450 °C)	T _C = 70 °C	- I _D	- 5.1		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C		- 5.4 ^{b,c}		
	T _A = 70 °C		- 4.3 ^{b,c}	A	
Pulsed Drain Current (t = 100 µs)		I _{DM}	- 18		
Continous Source-Drain Diode Current	T _C = 25 °C	- I _S	- 2.1		
	T _A = 25 °C		- 1 ^{b,c}		
	T _C = 25 °C	– P _D	2.5		
Maximum Power Dissipation	T _C = 70 °C		1.6	10/	
	T _A = 25 °C		1.25 ^{b,c}	W	
	T _A = 70 °C	1	0.8 ^{b,c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b,d}	$t \le 5 s$	R _{thJA}	75	100	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	40	50	0/11	

Notes:

a. Based on T_C = 25 °C.
b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 166 °C/W.

					R		
J20P4C				<u> </u>	<u>/B</u> www.VE	VBse Bsemi.o	
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,				- -			
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				1	1		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I _D = - 250 μA		- 19		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			4			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.5		- 2.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V			- 1	μA	
	000	$V_{DS} = -30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \leq$ - 5 V, V_{GS} = - 10 V	- 2.5			Α	
Drain-Source On-State Resistance ^a		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -4.4 \text{ A}$		0.046			
	R _{DS(on)}	$V_{GS} = -6 V, I_{D} = -4 A$		0.049		Ω	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.6 \text{ A}$		0.054			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.4 A		18		S	
Dynamic ^b	•	•		•	•	•	
Input Capacitance	C _{iss}			1295		pF	
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		150			
Reverse Transfer Capacitance	C _{rss}			130			
· · · · · · · · · · · · · · · · · · ·	Qg	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 5.4 A		24	36	nC	
Total Gate Charge				11.4	17		
Gate-Source Charge	Q _{gs}	V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 5.4 A		3.4			
Gate-Drain Charge	Q _{gd}			3.8			
Gate Resistance	R _g	f = 1 MHz	1.5	7.7	15.4	Ω	
Turn-On Delay Time	t _{d(on)}			13	20		
Rise Time	t _r	V_{DD} = - 15 V, R _L = 3.5 Ω		4	8		
Turn-Off Delay Time	t _{d(off)}	$\frac{1}{\text{ff}} I_{\text{D}} \cong -4.3 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		38	57	-	
Fall Time	t _f			6	12		
Turn-On Delay Time	t _{d(on)}			28	42	ns	
Rise Time	^r d(on) t _r	V _{DD} = - 15 V, R _L = 3.5 Ω		16	24		
Turn-Off Delay Time	-	$V_{DD} = -15 \text{ V}, \text{ K}_{L} = 3.5 \text{ V}_{2}$ $I_{D} \cong -4.3 \text{ A}, \text{ V}_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		30	45	-	
Fall Time	t _{d(off)} t _f	-10^{-1} -10^{-1}		10	20	-	
Drain-Source Body Diode Characteristic					20		
Continuous Source-Drain Diode Current	l _s	T _C = 25 °C			- 2.1		
Pulse Diode Forward Current (t = 100μ s)	I _{SM}				- 80	A	
Body Diode Voltage	V _{SD}	I _S = - 4.3 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	vsD t _{rr}	.5		- 0.8	23	ns	
Body Diode Reverse Recovery Time	Q _{rr}			7	14	nC	
		$I_F = -4.3 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{T}_J = 25 ^\circ\text{C}$			14		
Reverse Recovery Fall Time	t _a	4		8		ns	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

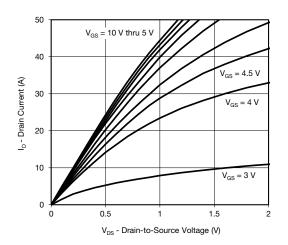
t_b

Reverse Recovery Rise Time

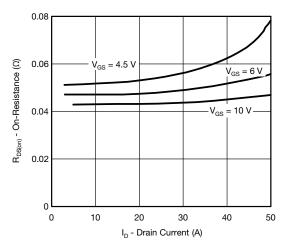
7



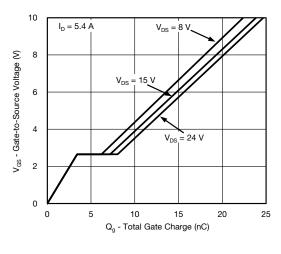




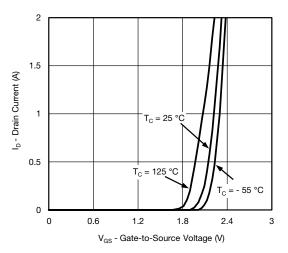
Output Characteristics



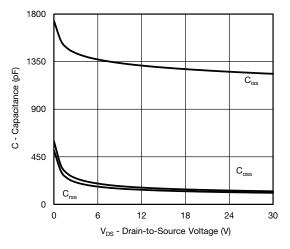
On-Resistance vs. Drain Current



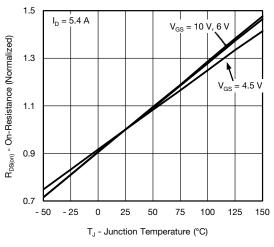
Gate Charge



Transfer Characteristics

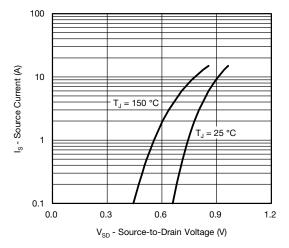






On-Resistance vs. Junction Temperature



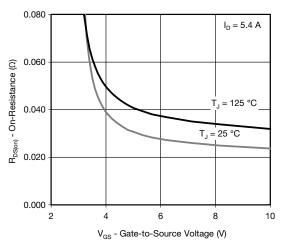


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

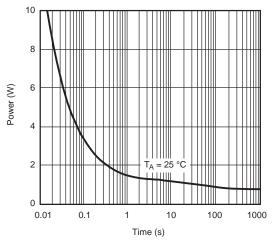




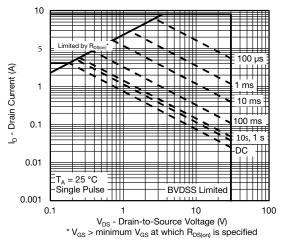
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



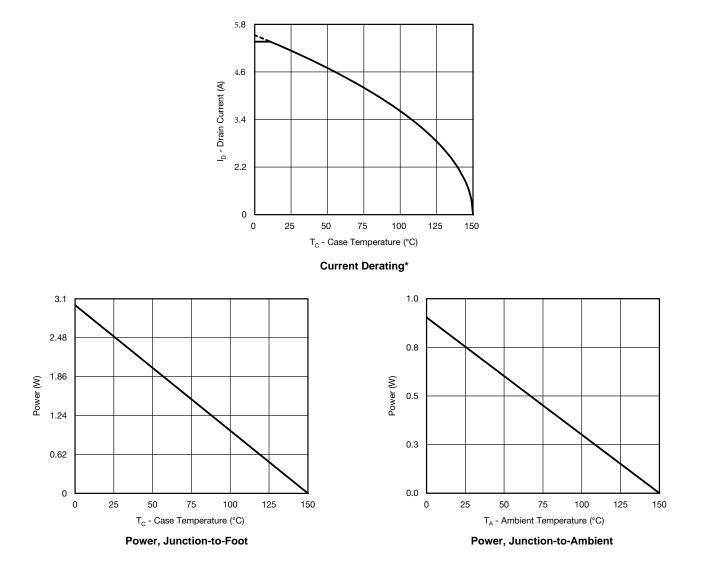
Single Pulse Power (Junction-to-Ambient)



Safe Operating Area, Junction-to-Ambient



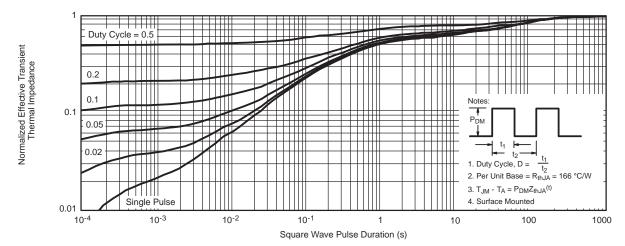
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



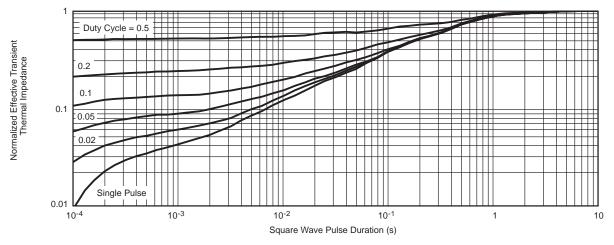
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

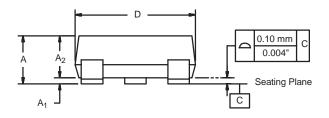


Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD



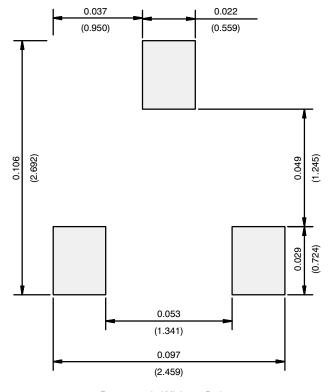




A A A ₁	Min 0.89	Max	Min	Мах		
	0.80			max		
Δ.	0.03	1.12	0.035	0.044		
~1	0.01	0.10	0.0004	0.004		
A ₂	0.88	1.02	0.0346	0.040		
b	0.35	0.50	0.014	0.020		
с	0.085	0.18	0.003	0.007		
D	2.80	3.04	0.110	0.120		
E	2.10	2.64	0.083	0.104		
E ₁	1.20	1.40	0.047	0.055		
е	0.95 BSC		0.0374 Ref			
e ₁	1.90 BSC		0.0748 Ref			
L	0.40	0.60	0.016	0.024		
L ₁	0.64 Ref		0.025	25 Ref		
S	0.50 Ref		0.020	0.020 Ref		
q	3°	8°	3°	8°		



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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